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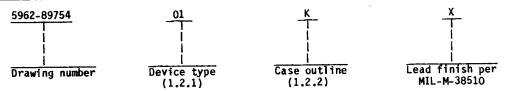
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DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device types. The device types shall identify the circuit function as follows:

Device type	Generic number	<u>Circuit function</u>
01	54F646	Transceivers/registers
02	54F648	Transceivers/registers, inverted

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

 K
 F-6 (24-lead, .640" x .420" x .090"), flat package

 L
 D-9 (24-lead, 1.280" x .310" x .200"), dual-in-line package

 3
 C-4 (28-terminal, .460" x .460" x .100"), square chip carrier package

1.3 Absolute maximum ratings.

1/ Must withstand the added PD due to short circuit test, e.g., Ios.

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1.4 Recommended operating conditions. +4.5 V dc minimum to +5.5 V dc maximum Supply voltage range (VCC) - - -2.0 V dc 0.8 V dc -18 mA -12 mA Maximum high level output current (IOH) -----48 m/A -55°C to +125°C 5.0 ns 1.5 ns 2.5 ns Pulše width ĆPAB, CPBA - - - - - - - - - - - - -5.0 ns 90 MHz

2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue Tisted in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

**SPECIFICATION** 

MILITARY

MIL-M-38510

Microcircuits, General Specification for.

**STANDARD** 

MILITARY

MIL-STD-883

Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103

List of Standardized Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

- 2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.
  - 3. REQUIREMENTS
- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

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- 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
- 3.2.2 Truth tables. The truth tables shall be as specified on figure 2.
- 3.2.3 Logic diagrams. The logic diagrams shall be as specified on figure 3.
- 3.2.4 Test circuit and switching waveforms. The test circuit and switching waveforms shall be as specified on figure 4.
  - 3.2.5 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.
- 3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- 3.5 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in MIL-BUL-103 (see 6.6 herein).
- 3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECC prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change. Notification of change to DESC-ECC shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.9 <u>Verification and review.</u> DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
  - a. Burn-in test, method 1015 of MIL-STD-883.
    - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
    - (2)  $T_A = +125^{\circ}C$ , minimum.
  - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

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mA   All mA   All mA   All mA   All v   All v   All v   All v   All s)   All	1, 2, 3   1, 2, 3   1, 2, 3   1, 2, 3   1, 2, 3   1, 2, 3	Min   2.0	0.55 -1.2 20	V V V µA
nA   All nA   All v   All ins) v   V   v   v	1, 2, 3		20	٧
v All ins); v V	1, 2, 3		20	٧
V   All	1, 2, 3		20	
ins				μ <b>Α</b>
v ] ) ]			100	l I
) 1	1, 2, 3			
A11   A11	1, 2, 3		1.0	mA
<del>- i</del>	i	1     	-0.6	l mA l
   A11	1, 2, 3	  -100 	  -225 	l mA l
V A11	1, 2, 3		70	μА
; <b>v</b>	1, 2, 3		-650	
All	1, 2, 3		135	mA
)   	1, 2, 3	   	150	l mA
	1, 2, 3	   	150	mA
A11	7,8		1	
	A11	A11   1, 2, 3   1, 2, 3   1, 2, 3	A11   1, 2, 3	1, 2, 3   135 1, 2, 3   150

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TABLE I. Electrical performance characteristics - Continued. Unit Test Symbol | Conditions Device Group A Limits -55°C < T<sub>C</sub> < +125°C unless otherwise specified IsubgroupsT types Min Max Propagation delay time, An, Bn to Bn, An or An, Bn to Bn, An 9 7 <u>C</u>լ = 50 pF 1 V<sub>CC</sub> = 5.0 V A11 tPLH1 ns  $R_1 = 500\Omega$  $R_2 = 500\Omega$ 8  $V_{CC} = 4.5 \text{ V to}$ 1 see figure 4 01 10, 11 5.5 Y 02 9 1 6.5  $V_{CC} = 5.0 \text{ V}$ A11 tpHL1  $V_{CC} = 4.5 \text{ V to}$ 8 10, 11 1 Propagation delay time, <u>CPBA</u>, CPAB to An, Bn,  $V_{CC} = 5.0 V$ 9 7 A11 2 **ኒ**PLH2 ns An, Bn V<sub>CC</sub> = 4.5 V to 5.5 V 8.5 2 10, 11 9 8  $V_{CC} = 5.0 V$ A11 2 tPHL2 V<sub>CC</sub> = 4.5 V to 9.5 10, 11 2 5.5 V Propagation delay time, SBA, SAB to An, Bn, Ān, Bn V<sub>CC</sub> = 5.0 V A11 9 2 8.5 ns tplH3 V<sub>CC</sub> = 4.5 V to 5.5 V 10, 11 2 11  $V_{CC} = 5.0 V$ A11 9 2 8 tpHL3 V<sub>CC</sub> = 4.5 V to 5.5 V 10, 11 2 10 Output enable time, OE to An, Bn, An, Bn  $V_{CC} = 5.0 V$ A11 9 2 8.5 ns tPZH1 V<sub>CC</sub> = 4.5 V to 5.5 V 10, 11 10  $V_{CC} = 5.0 \text{ V}$ 9 2 8.5 A11 ፟ቑZL1 | V<sub>CC</sub> = 4.5 V to 2 10, 11 10 5.5 V See footnotes at end of table. SIZE **STANDARDIZED** Α 5962-89754 MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER **REVISION LEVEL** SHEET DAYTON, OHIO 45444 6

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Test	  Symbol	Condi	Device	Group A	Lim	its	Unit	
		-55°C < Tc   unless otherw	√ +125°C  Tise specified	types	subgroups    	Min	   Max	
Output enable time, DIR to An, Bn, An, Bn	tpzH2	  C <sub>L</sub> = 50 pF  R <sub>1</sub> = 500Ω	V <sub>CC</sub> = 5.0 V	   A11 	9	2	8.5	l ns
	! ! !	lR2 = 500Ω  see figure 4 	V <sub>CC</sub> = 4.5 V to 5.5 V	All	10, 11	2	10	 
	tpZL2	-    - 	V <sub>CC</sub> = 5.0 V	   A11 	   9   	2	10	  - 
	1		$V_{CC} = 4.5 \text{ V to}$	   A11 	10, 11	2	12	   
Output disable time, OE to An, Bn, An, Bn	tpHZ1	T   	V <sub>CC</sub> = 5.0 V	A11	9	1	7.5	ns
,			V <sub>CC</sub> = 4.5 V to 5.5 V	A11	10, 11	1	9	
	t <sub>PLZ1</sub>	-   	V <sub>CC</sub> = 5.0 V	L All	]   9 	1	7.5	
		1	V <sub>CC</sub> = 4.5 V to	   A11 	10, 11	l   1 	   9 	   
Output disable time, DIR to An, Bn, An, Bn	tPHZ2	T   	V <sub>CC</sub> = 5.0 V	   All	9	   1 	7.5	ns
	1		V <sub>CC</sub> = 4.5 V to	All	10, 11	!   1 	9	1
	tpLZ2	-!   	V <sub>CC</sub> = 5.0 V	All	9	1	10	<u> </u>
	1	1	V <sub>CC</sub> = 4.5 V to	A11	10, 11	1	12	

<sup>1/</sup> For I/O ports, the parameters  $I_{
m IH}$  and  $I_{
m IL}$  include the off-state output current.

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<sup>2/</sup> Not more than one output will be shorted at one time and the duration of the short circuit condition shall not exceed one second.

01 02 Device types Case K and L 3 outlines K and L Terminal Terminal symbol Terminal symbol number CPAB **CPAB** SAB DIR **CPAB** 2 CPAB SAB SAB SAB 3 DIR DIR A1 DIR ΑI A2 A3 A5 A6 A7 A8 GND B8 B7 B6 B5 B4 B1 B1 B1 AI A2 5 A2 A1 6 A3 A2 A4 A3 Ā3 8 A5 NC NC A4 A5 A4 A6 10 **A7** A5 Ã6 A7 11 12 A8 A6 GND A7 **X8** 13 14 15 В8 84 GND **B7** GND В6 NC NC B8 B7 16 17 В8 **B**5 В4 в7 18 **B3** В6 **B6** B5 B4 **B2** В5 19 20 21 22 23 24 25 81 0E **B4 B3 B3** SBA NC NC SBA **B**2 CPBA **CPBA** В2 **V**CC BI **V**CC В1 ŌE <u>OE</u> 26 27 SBA SBA **CPBA CPBA** ---28 ---ACC **VCC** 

NC = No connection

FIGURE 1. Terminal connections.

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# Device type 01

		Input	S			Inputs/o	utputs <sup>1/</sup>	Operating
DIR	ŌE	CPAB	СРВА	SAB	SBA	A <sub>O</sub> through A <sub>7</sub>	   B <sub>O</sub> through B <sub>7</sub> 	mode   
X   X   L   L   H	H L L L	H/L X X X H/L	H/L X X X X	X X X L H	X   X   L   H ! X	Input Input Output Output Input Input	Input   Input   Input   Input   Output   Output	Isolation   Store A and B data   Real time B data to A bus   Stored B data to A bus   Real time A data to B bus   Stored A data to B bus

# Device type 02

	Inputs					Inputs/o	utputs <sup>1/</sup>	Operating
DIR	ŌE	СРАВ	СРВА	SAB	SBA	⊼ <sub>0</sub> through ⊼ <sub>7</sub>	l   B <sub>O</sub> through B7 	mode   
X   X   L   L   H	H H L L	H/L X X X H/L	H/L X X X X	X X X X L H	X I X I L I H X	Input Input Output Output Input Input Input	Input   Input   Input   Input   Output   Output	Isolation   Store A and B data   Real time B data to A bus   Stored B data to A bus   Real time A data to B bus   Stored A data to B bus

= High voltage level
= Low voltage level

= Irrelevant

= Low to high clock transition
H/L = High or low voltage level

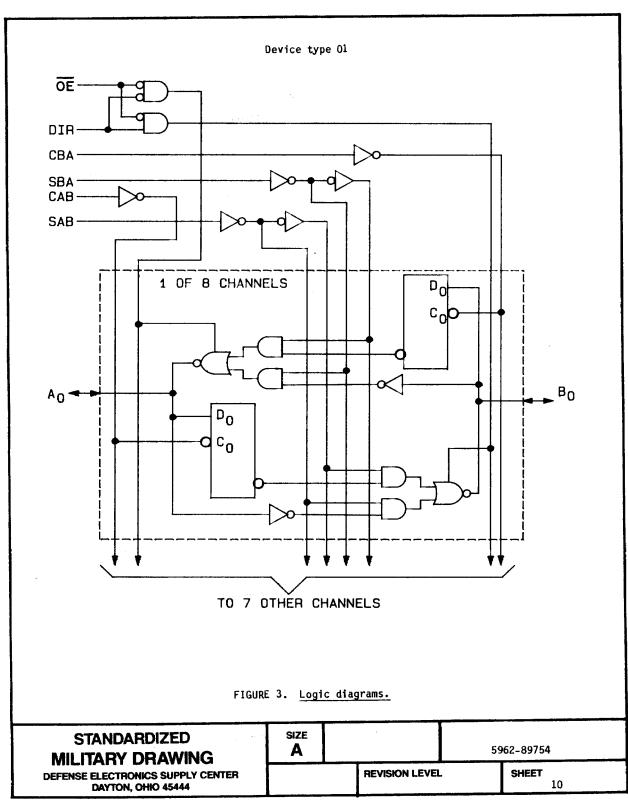
1/ The data output functions may be enabled or disabled by various signals at OE or DIR inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low to high transition on the clock inputs.

FIGURE 2. Truth tables.

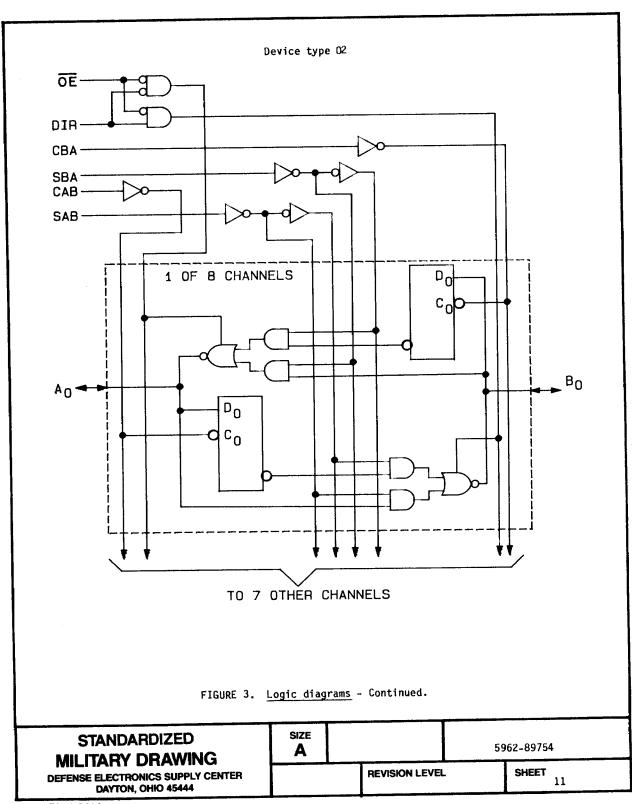
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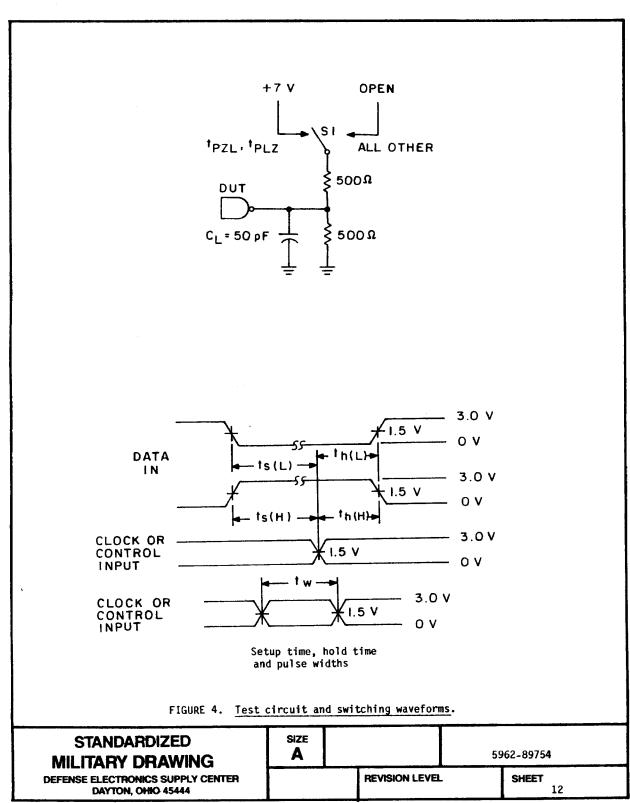
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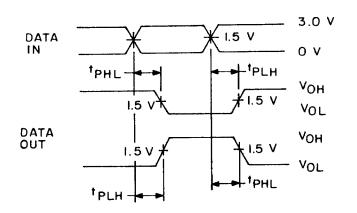
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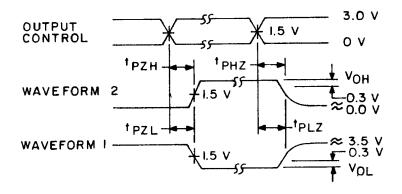
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Propagation delay time



Three-state output high and low enable and disable times

### NOTES:

 ${f C}_{f L}$  includes probe and jig capacitance. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

All input pulses have the following characteristics: PRR = 1 MHz, t<sub>r</sub> = t<sub>f</sub> = 2.5 ns, duty cycle = 50 percent.
 When measuring propagation delay times of three-state outputs, switch Sl is

When measuring pulse widths  $t_r=t_f < 1~\text{ns.}$  The outputs are measured one at a time with one input transition per measurement.

FIGURE 4. Test circuit and switching waveforms - Continued.

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4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-SID-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

# 4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroups 7 and 8 tests shall verify the truth table as specified on figure 2 herein.

# 4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
  - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
  - (2)  $T_A = +125^{\circ}C$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9
Group A test requirements (method 5005)	1   1, 2, 3, 7, 8,   9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

<sup>\*</sup>PDA applies to subgroup 1.

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- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
  - 6. NOTES
- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECC, telephone (513) 296-6022.
- 6.5 Comments. Comments on this drawing should be directed to DESC-ECC, Dayton, Ohio 45444, or telephone (513) 296-8525.

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6.6 Approved source of supply. An approved source of supply is listed in MIL-BUL-103.

Additional sources will be added to MIL-BUL-103 as they become available. The vendor listed in MIL-BUL-103 has agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECC. The approved source of supply listed below is for information purposes only and is current only to the date of the last action of this document.

Military drawing part number	l Vendor I l CAGE   l number	Vendor similar part number 1/
5962-8975401KX	   27014   	54F646FMQB
5962-8975401LX	27014	54F646SDMQB
5962-89754013X	27014	54F646LMQB
5962-8975402KX	27014	54F648FMQB
5962-8975402LX	27014	54F648SDMQB
5962-89754023X	27014	54F648LMQB

 $\frac{1}{a} \begin{tabular}{ll} \hline \textbf{Caution.} & \textbf{Do not use this number for item} \\ \hline \textbf{acquisition.} & \textbf{Items acquired to this number may} \\ \textbf{not satisfy the performance requirements of this} \\ \hline \end{tabular}$ drawing.

Vendor CAGE number

27014

Vendor name

and address

National Semiconductor Corporation 2900 Semiconductor Drive Santa Clara, CA 95052 Point of contact: 333 Western Avenue

South Portland, ME 04106

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